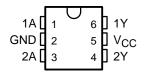
- **Available in the Texas Instruments** NanoStar™ and NanoFree™ Packages
- Supports 5-V V<sub>CC</sub> Operation
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 4.1 ns at 3.3 V
- Low Power Consumption, 10-µA Max I<sub>CC</sub>
- ±24-mA Output Drive at 3.3 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) <0.8 V at  $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot) >2 V at  $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Ioff Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- **ESD Protection Exceeds JESD 22** 
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

### **DBV OR DCK PACKAGE** (TOP VIEW)



#### YEA OR YZA PACKAGE (BOTTOM VIEW)



## description/ordering information

This dual inverter is designed for 1.65-V to 5.5-V V<sub>CC</sub> operation.

The SN74LVC2G04 performs the Boolean function  $Y = \overline{A}$ .

NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

#### ORDERING INFORMATION

TA	PACKAGE <sup>†</sup>	PACKAGE <sup>†</sup>		TOP-SIDE MARKING <sup>‡</sup>
	NanoStar™ WCSP (DSBGA) – YEA (Lead)	Tape and reel	SN74LVC2G04YEAR	CC
–40°C to 85°C	NanoFree™ WCSP (DSBGA) – YZA (Lead-free)	Tape and reel	SN74LVC2G04YZAR	00_
	SOT (SOT-23) – DBV	Tape and reel	SN74LVC2G04DBVR	C04_
	SOT (SC-70) – DCK	Tape and reel	SN74LVC2G04DCKR	CC_

<sup>†</sup>Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site. YEA/YZA: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

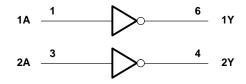
NanoStar and NanoFree are trademarks of Texas Instruments.

ISTRUMENTS

## FUNCTION TABLE (each inverter)

INPUT A	OUTPUT Y
Н	L
L	Н

## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	
Input voltage range, V <sub>I</sub> (see Note 1)	0.5 V 10 6.5 V
(see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2)	$\dots$ -0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–50 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Continuous output current, I <sub>O</sub>	±50 mA
Continuous current through V <sub>CC</sub> or GND	±100 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 3): DBV package	
DCK package	
YEA/YZA package	143°C/W
Storage temperature range, T <sub>Stg</sub>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The value of  $V_{\hbox{CC}}$  is provided in the recommended operating conditions table.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-7.



SN74LVC2G04

## recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
Vaa	Cupply voltage	Operating	1.65	5.5	V
VCC	Supply voltage	Data retention only	1.5		V
		V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$		
V	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V
VIH	nigh-level input voltage	V <sub>CC</sub> = 3 V to 3.6 V	2		V
		V <sub>CC</sub> = 4.5 V to 5.5 V	$0.7 \times V_{CC}$		
		V <sub>CC</sub> = 1.65 V to 1.95 V		0.35 × V <sub>CC</sub>	
\ \.	Low level input valtage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	,
VIL	Low-level input voltage	V <sub>CC</sub> = 3 V to 3.6 V		8.0	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		$0.3 \times V_{CC}$	
٧ <sub>I</sub>	Input voltage		0	5.5	V
٧o	Output voltage		0	Vcc	V
		V <sub>CC</sub> = 1.65 V		-4	
	High-level output current $V_{CC} = 2.3 \text{ V}$ $V_{CC} = 3 \text{ V}$	V <sub>CC</sub> = 2.3 V		-8	
ІОН		Vec - 3 V		-16	mA
		vCC = 2 v		-24	
		V <sub>CC</sub> = 4.5 V		-32	
		V <sub>CC</sub> = 1.65 V		4	
		V <sub>CC</sub> = 2.3 V		8	
lOL	Low-level output current	V <sub>CC</sub> = 3 V	16	16	mA
		vCC = 2 v		24	
		V <sub>CC</sub> = 4.5 V		32	
		$V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}, 2.5 \text{ V} \pm 0.2 \text{ V}$	20		
Δt/Δν	Input transition rise or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		10	ns/V
		$V_{CC} = 5 V \pm 0.5 V$		5	
TA	Operating free-air temperature		-40	85	°C

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SCES195G - APRIL 1999 - REVISED OCTOBER 2002

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETE	TEST CONDITIONS	VCC	MIN	TYP†	MAX	UNIT	
	Ι <sub>ΟΗ</sub> = –100 μΑ	1.65 V to 5.5 V	V <sub>CC</sub> -0.1		·		
	$I_{OH} = -4 \text{ mA}$	1.65 V	1.2		·		
No.	$I_{OH} = -8 \text{ mA}$	2.3 V	1.9			V	
VOH	$I_{OH} = -16 \text{ mA}$	2.//	2.4			V	
	$I_{OH} = -24 \text{ mA}$	3 V	2.3				
	$I_{OH} = -32 \text{ mA}$	4.5 V	3.8				
	I <sub>OL</sub> = 100 μA	1.65 V to 5.5 V			0.1		
	I <sub>OL</sub> = 4 mA	1.65 V			0.45		
	I <sub>OL</sub> = 8 mA	2.3 V			0.3	V	
V <sub>OL</sub>	I <sub>OL</sub> = 16 mA	3 V		0.4			
	I <sub>OL</sub> = 24 mA	3 V			0.55		
	I <sub>OL</sub> = 32 mA	4.5 V			0.55		
I <sub>I</sub> A inputs	V <sub>I</sub> = 5.5 V or GND	0 to 5.5 V			±5	μΑ	
l <sub>off</sub>	V <sub>I</sub> or V <sub>O</sub> = 5.5 V	0			±10	μΑ	
ICC	$V_I = 5.5 \text{ V or GND}, \qquad I_O = 0$	1.65 V to 5.5 V			10	μΑ	
ΔlCC	One input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND	3 V to 5.5 V			500	μΑ	
C <sub>i</sub>	$V_I = V_{CC}$ or GND	3.3 V		3.5		pF	

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

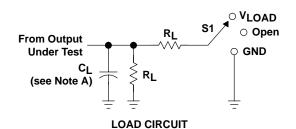
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> =		UNIT						
	(1141 01)	(0011 01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> pd	А	Υ	3.1	8	1.5	4.4	1.2	4.1	1	3.2	ns

## operating characteristics, $T_A = 25^{\circ}C$

I	PARAMETER		METER TEST CONDITIONS		$V \mid V_{CC} = 2.5 \text{ V} \mid V_{CC} = 3.3 \text{ V}$		V <sub>CC</sub> = 5 V	UNIT
			TEST CONDITIONS	TYP	TYP	TYP	TYP	ONIT
	C <sub>pd</sub>	Power dissipation capacitance	f = 10 MHz	14	14	14	16	pF

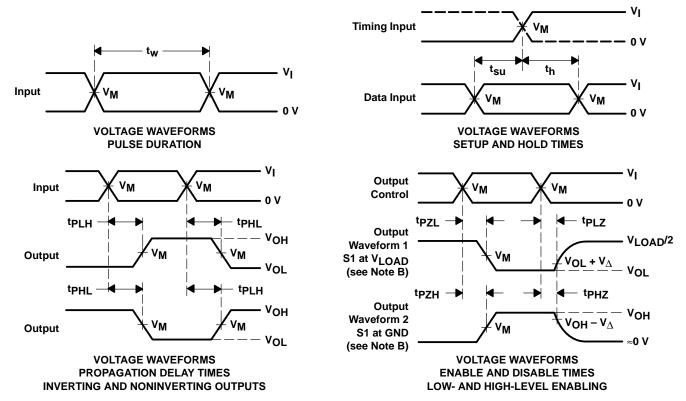


### PARAMETER MEASUREMENT INFORMATION



TEST	<b>S</b> 1
tPLH/tPHL	Open
tPLZ/tPZL	VLOAD
tPHZ/tPZH	GND

.,	INF	PUTS	.,				.,
VCC	٧ <sub>I</sub>	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	VLOAD	CL	$R_{L}$	$oldsymbol{V}_\Delta$
1.8 V $\pm$ 0.15 V	VCC	≤2 ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	30 pF	<b>1 k</b> Ω	0.15 V
2.5 V $\pm$ 0.2 V	VCC	≤ <b>2</b> ns	V <sub>CC</sub> /2	2×VCC	30 pF	500 $\Omega$	0.15 V
3.3 V $\pm$ 0.3 V	3 V	≤2.5 ns	1.5 V	6 V	50 pF	500 $\Omega$	0.3 V
5 V $\pm$ 0.5 V	VCC	≤2.5 ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	50 pF	500 $\Omega$	0.3 V



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>Ω</sub> = 50 Ω.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third—party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265

Copyright © 2002, Texas Instruments Incorporated